



## P-Channel 12 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)			
	0.156 at V <sub>GS</sub> = - 4.5 V	1.18				
- 12	0.190 at V <sub>GS</sub> = - 2.5V	1.07	6.7 nC			
	0.245 at V <sub>GS</sub> = - 1.8V	0.49				

### **FEATURES**

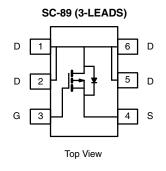
- TrenchFET® Power MOSFET
- 100 % R<sub>g</sub> Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

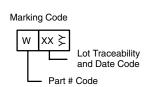


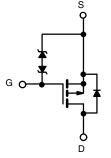
HALOGEN FREE

### **APPLICATIONS**

· Load Switch for Portable Devices







Ordering Information: Si1065X-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25 °C, unless otherwise noted)							
Parameter		Symbol	Limit	Unit			
Drain-Source Voltage		V <sub>DS</sub>	- 12	V			
Gate-Source Voltage		$V_{GS}$	± 8	V			
Continuous Drain Current (T <sub>.I</sub> = 150 °C)	T <sub>A</sub> = 25 °C	ı	- 1.18 <sup>b, c</sup>	A			
Continuous Diam Curient (1j = 150°C)	T <sub>A</sub> = 70 °C	l <sub>D</sub>	- 0.94 <sup>b, c</sup>				
Pulsed Drain Current		I <sub>DM</sub>	- 8	A			
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 0.2 <sup>b, c</sup>				
Mariana Banas Biratastian	T <sub>A</sub> = 25 °C	D.	0.236 <sup>b, c</sup>	w			
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 70 °C	P <sub>D</sub>	0.151 <sup>b, c</sup>				
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
	t ≤ 5 s	R <sub>thJA</sub>	440	530	°C/W	
Maximum Junction-to-Ambient <sup>a, b</sup>	Steady State State		540	650		

- a. Maximum under steady state conditions is 650 °C/W.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.

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Parameter	Symbol	herwise noted)  Test Conditions	Min.	Тур.	Max.	Unit	
Static	<b> </b>			.,,,,	1	<u> </u>	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = - 250 μA	- 12			V	
V <sub>DS</sub> Temperature Coefficient	ΔV <sub>DS</sub> /T <sub>J</sub>			- 8.47			
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = - 250 μA		2.33		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.45		- 0.95	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zana Oata Wallana Busin Oamant	-	V <sub>DS</sub> = - 12 V, V <sub>GS</sub> = 0 V			- 1	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = -12 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 \text{ °C}$			- 10	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = \ge 5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 8			Α	
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 1.18 A		0.108	0.156		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 1.07 A		0.131	0.190	Ω	
		V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 0.49 A		0.158	0.245		
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = - 6 V, I <sub>D</sub> = - 1.18 A		5.18		S	
Dynamic <sup>b</sup>			•				
Input Capacitance	C <sub>iss</sub>			480			
Output Capacitance	C <sub>oss</sub>	$V_{DS} = -6 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		190		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			145			
Total Gate Charge	0	$V_{DS} = -6 \text{ V}, V_{GS} = -5 \text{ V}, I_D = -1.18 \text{ A}$		7.2	10.8		
Total date onarge	$Q_g$			6.7	10.1	nC	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -6 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -1.18$		0.84		IIC IIC	
Gate-Drain Charge	$Q_{gd}$			2.7			
Gate Resistance	$R_g$	f = 1 MHz		10	15	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			13	19.5		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 6 V, $R_L$ = 6.32 $\Omega$		27	40.5	ns	
Turn-Off DelayTime	$t_{d(off)}$	$I_D \cong$ - 0.95 A, $V_{GEN} =$ - 4.5 V, $R_g = 1 \Omega$		45	67.5		
Fall Time	t <sub>f</sub>			27	40.5		
Drain-Source Body Diode Characteristics							
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				8	Α	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = - 0.63 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			29.2	44	nC	
Body Diode Reverse Recovery Charge	$Q_{rr}$	I <sub>F</sub> = - 0.7 A, dl/dt = 100 A/μs		10.22	15.3	ns	
Reverse Recovery Fall Time	t <sub>a</sub>	1 0.7 Λ, αι/αι – 100 Λ/μδ		13.7			
Reverse Recovery Rise Time	t <sub>b</sub>			15.5			

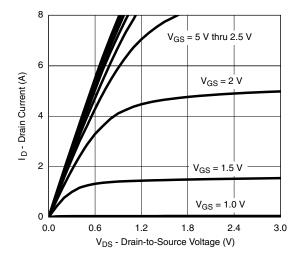
### Notes:

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

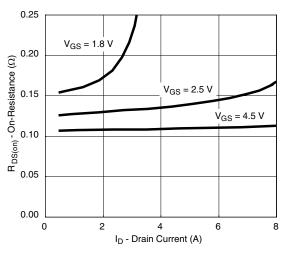
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



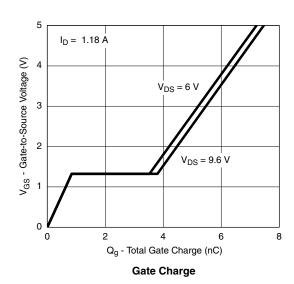
### **TYPICAL CHARACTERISTICS** ( $T_A = 25$ °C, unless otherwise noted)

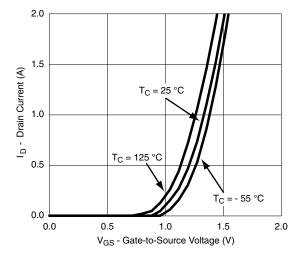


### **Output Characteristics**

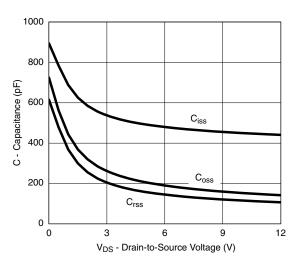


On-Resistance vs. Drain Current

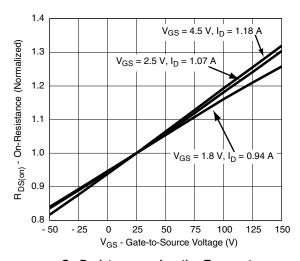




Transfer Characteristics Curves vs. Temp.



Capacitance

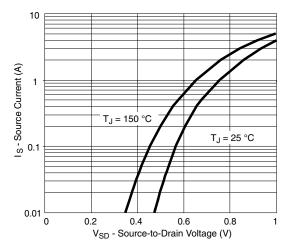


On-Resistance vs. Junction Temperature

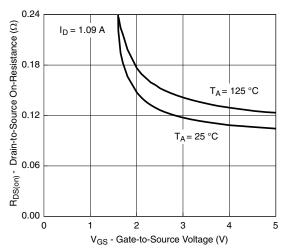
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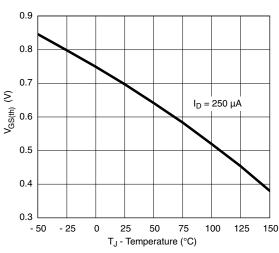
### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



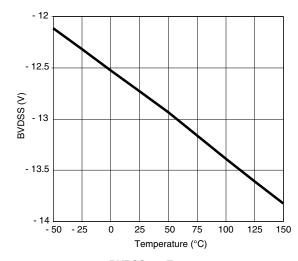
### Source-Drain Diode Forward Voltage



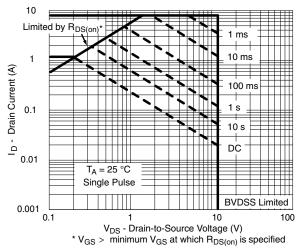
 $R_{DS(on)}$  vs.  $V_{GS}$  vs. Temperature



Threshold Voltage



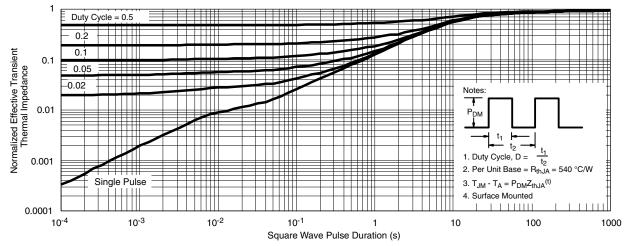
**BVDSS vs. Temparture** 



Safe Operating Area, Junction-to-Ambient



## **TYPICAL CHARACTERISTICS** ( $T_A = 25$ °C, unless otherwise noted)

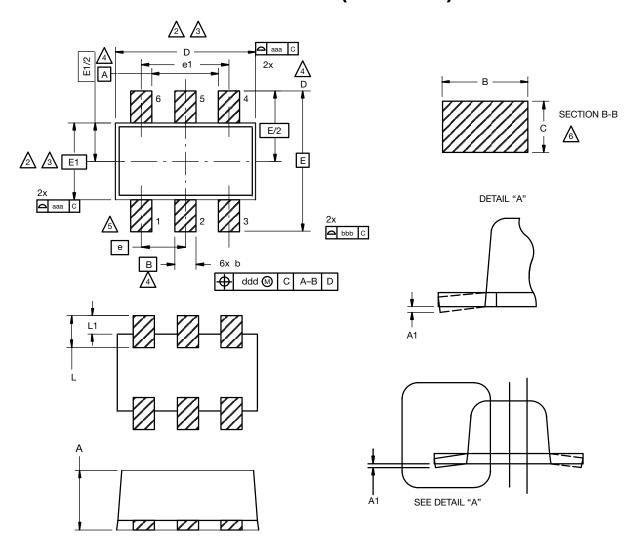


Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?74320.



## **SC-89 6-Leads (SOT-563F)**



### Notes

1. Dimensions in millimeters.

Dimension D does not include mold flash, protrusions or gate burrs. Mold flush, protrusions or gate burrs shall not exceed 0.15 mm per dimension E1 does not include interlead flash or protrusion, interlead flash or protrusion shall not exceed 0.15 mm per side.

Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and the bottom of the plastic body.

ADatums A, B and D to be determined 0.10 mm from the lead tip.

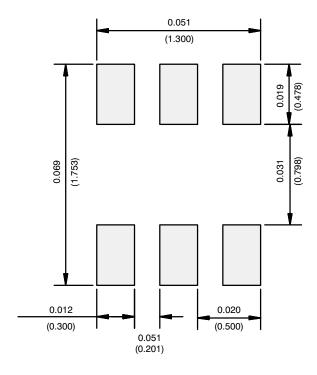
A Terminal numbers are shown for reference only.

These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.

DIM.	MILLIMETERS				
DIW.	MIN.	NOM.	MAX.		
Α	0.56	0.58	0.60		
A1	0	0.02	0.10		
b	0.15	0.22	0.30		
С	0.10	0.14	0.18		
D	1.50	1.60	1.70		
E	1.50	1.60	1.70		
E1	1.15	1.20	1.25		
е	0.45	0.50	0.55		
e1	0.95	1.00	1.05		
L	0.25	0.35	0.50		
L1	0.10	0.20	0.30		
C14-0439-Rev. C, 11-Aug-14 DWG: 5880					



### **RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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